

2018 EDITORIAL CALENDAR

Issue	Featured and New Product Coverage	Important Industry Events
January	Antennas, Cable Assemblies, Couplers, Test and Measurement	2018 IEEE Radio and Wireless Symposium , Anaheim January 14-17, 2018 DesignCon , Santa Clara January 31-February 1, 2018
February	Design Tools, Power Amplifiers Filters, Mil-Aero Products	Satellite 2018 , Washington DC March 12-15, 2018
March	Passive Components-Attenuators, DC Blocks/Bias Tees	NAB , Las Vegas, March 7-12, 2018
April	Test & Measurement Tools Cable Assemblies, Integrated Assemblies	WAMICON , Clearwater, April 9-10, 2018
May	Active Components, Switches, Mixers, Phase Shifters, IMS2018 Show Issue	IMS 2018 , Philadelphia June 10-15, 2018
June	Frequency Control Components, Low Loss Cables, Design Tools Update	IEEE International Conference on Mobile Terahertz Systems 2018 (ICMTS 2018) Duisburg July 2-4, 2018
July	Passive Components, Isolators, Circulators, Connectors, Antennas	IEEE EMC-Long Beach July 30-August 3, 2018
August	Defense Electronics EDA, Automated Test, Test Cables, Signal Generators	IEEE AUTOTESTCON , National Harbor, September 17-20, 2018
September	Millimeter Connectors and Components, Detectors EuMW 2018 Preview	EuMW2018 , Madrid September 23-28, 2018
October	Circuit Materials, Interconnects, Base Station Products, Network Analyzers, Mil-Spec Products	MILCOM 2018 , Baltimore TBA, 2018
November	Coaxial Adapters, Low Noise Amplifiers, Modular Test Equipment	AOC , Washington DC November 27-29, 2018
December	Passive Components, Couplers and Power Dividers, Crystal Oscillators, VCOs, YIG Oscillators	2019 IEEE Radio and Wireless Symposium , Anaheim-January (TBD), 2019

Regular monthly columns include:

Commentary ◦ In the News ◦ Meetings & Events ◦ New Products ◦ Featured Products

In addition to the product coverage above, each monthly issue will offer the reader a balanced mix of subject matter at levels of technical depth ranging from fundamental tutorials to advanced theory. Each month the subject matter is carefully selected to be both practical and useful to engineers who are developing high frequency and high-speed systems for applications in wireless and wireless communications, military and civilian defense, navigation, computing, imaging, and more.

Additional technical articles can be published in each issue, covering other topics

AD CLOSING DATES: 15th of the prior month (next business day if weekend)

AD MATERIAL DEADLINE: 20th of the prior month.

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Editorial Submissions

Regular Columns

Meetings & Events, In the News, Design Notes, High Frequency Applications

Press Releases

Press releases for our informational columns should be sent by the first of the month prior to the desired publication date (e.g., April 1 for the May issue). Late-breaking news can be accommodated, but please advise the editors of urgent items by telephone or e-mail.

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Article Contributions

We encourage the submission of technical articles, application notes and other editorial contributions. These may be on the topics noted above, or any other subject of current interest. Contact us with article ideas:

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